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Dated: July 12, 2005

Signature:

(David T. Yang)

Docket No.: 535352000500
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Here Patent Application of:
Alan E. REAMON et al.

Application No.: 09/705,134

Confirmation Number:

Filed: November 2, 2000

Art Unit: 2817

For: ON-CHIP MULTILAYER METAL SHIELDED
TRANSMISSION LINE

Examiner: B. T. Lee

SUBMISSION OF DRAWINGS

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Submitted herewith is one set (three sheets, six figures) of drawings for filing in the above-identified patent application. Kindly substitute the enclosed drawings for the drawings submitted with the originally filed application.

Dated: July 12, 2005

Respectfully submitted,

By

David T. Yang

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